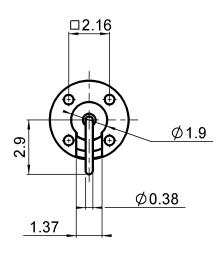
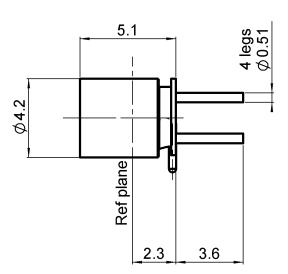




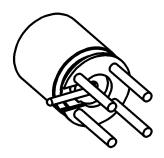
STRAIGHT JACK RECEPTACLE PIN IN PASTE - LIMITED DETENT

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All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
Body	STAINLESS STEEL + BRASS	PASSIVATED + GOLD 0.5 OVER NICKEL 2
Center contact	BERYLLIUM COPPER	GOLD 1.27 OVER NICKEL 1.27
Outer contact		
Insulator	PTFE	
Gasket		
Others parts	-	-
-	-	-
-	-	-



## **Technical Data Sheet**

STRAIGHT JACK RECEPTACLE PIN IN PASTE - LIMITED DETENT

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#### **PACKAGING**

Standard	Unit	Other
100	Contact us	Contact us

## **ELECTRICAL CHARACTERISTICS**

Impedance Frequency VSWR\*\*\* GHz 0-40\* 1.15\*\* 0,0000

x F(GHz) Maxi √F(GHz) dB Maxi Insertion loss 0.12\* RF leakage - F(GHz)) dB Maxi NA - ( Voltage rating 335 Veff Maxi Dielectric withstanding voltage 500 Veff mini Insulation resistance 5000

 $M\Omega$  mini

#### **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating End N mini Axial force – Opposite end 6.8 N mini NA Torque N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini 0,3500 Weight

### **ENVIRONMENTAL**

Operating temperature -65/+165 °C Hermetic seal NA Atm.cm3/s Panel leakage NA

### **SPECIFICATION**

#### **OTHER CHARACTERISTICS**

Assembly instruction:

### Others:

Compliant with MIL-STD-348

- \*Coaxial transmission line only
- \*\*DC-12.4 Ghz (Coaxial transmission line only)
- \*\*\*Performance strongly depends on layout and PCB material





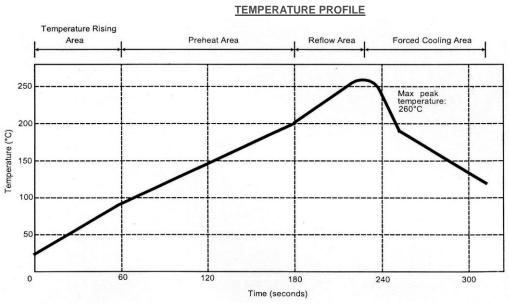
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# **SOLDER PROCEDURE**

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 microns (5.85 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
  - Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow.

  Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

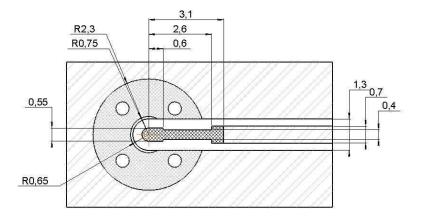


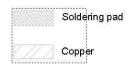


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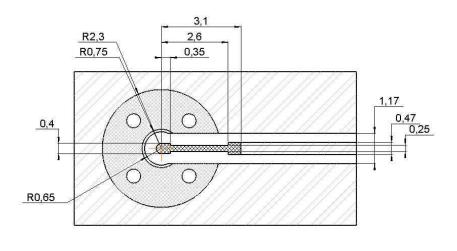
## **RECOMMENDED PAD DIMENSIONS:**

Substrate: RT5880 thickness 0.254mm, with copper layer 35µm on both sides: Add vias between both sides along upper ground plane according to engineering practise





Substrate: RO4350 thickness 0.254mm, with copper layer 35µm on both sides: Add vias between both sides along upper ground plane according to engineering practise







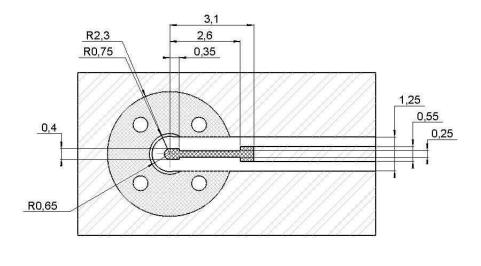


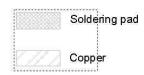
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Substrate: RO6002 thickness 0.254mm, with copper layer 35µm on both sides:

Add vias between both sides along upper ground plane according to engineering practise





# SHADOW FOR VIDEO CAMERA

